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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/625,166	07/22/2003	Janos Fucsko	MI22-2246	8008	
21567 7	590 12/21/2005		EXAMINER		
WELLS ST	IOHN P.S. AVENUE, SUITE 1300		SMOOT, STEPHEN W		
SPOKANE, W			ART UNIT	PAPER NUMBER	
·			2813		

DATE MAILED: 12/21/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

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		Application No.	Applicant(s)	Ĺ,		
Office Action Summary		10/625,166	FUCSKO ET AL.			
		Examiner	Art Unit			
		Stephen W. Smoot	2813			
Period fo	The MAILING DATE of this communication app or Reply	ears on the cover sheet with the o	orrespondence addre	ess		
A SH WHIC - Exter after - If NO - Failu Any I	ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DANSIONS of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. Operiod for reply is specified above, the maximum statutory period vere to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing ed patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tinuity will apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONE	N. nely filed the mailing date of this comn ED (35 U.S.C. § 133).			
Status						
2a) <u></u> □	Responsive to communication(s) filed on <u>18 Add</u> This action is FINAL . 2b) This Since this application is in condition for allowar closed in accordance with the practice under E	action is non-final. nce except for formal matters, pr		nerits is		
Dispositi	ion of Claims					
5)□ 6)⊠ 7)□ 8)□	Claim(s) 1-62 is/are pending in the application. 4a) Of the above claim(s) See Continuation Shows Claim(s) is/are allowed. Claim(s) 1-8,13,15,20,26,30-32,34-40,43,45,45 Claim(s) is/are objected to. Claim(s) are subject to restriction and/origin Papers.	<u>eet</u> is/are withdrawn from consid 7 <u>,52,58 <i>and</i> 62</u> is/are rejected.	eration.			
• •	ion Papers					
10)⊠	The specification is objected to by the Examine The drawing(s) filed on <u>22 July 2003</u> is/are: a)[Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct The oath or declaration is objected to by the Examine	☑ accepted or b)☐ objected to drawing(s) be held in abeyance. Se ion is required if the drawing(s) is ob	e 37 CFR 1.85(a). ojected to. See 37 CFR			
Priority (under 35 U.S.C. § 119					
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
2) Notice 3) Inform	et(s) te of References Cited (PTO-892) te of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) ter No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal I 6) Other:		52)		

Continuation of Disposition of Claims: Claims withdrawn from consideration are 9-12,14,16-19,21-25,27-29,33,41,42,44,46,48-51,53-57 and 59-61.

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DETAILED ACTION

This Office action is in response to applicant's amendment received on 18 August 2005, which includes a declaration under 37 CFR 1.132.

Response to Amendment

1. The declaration under 37 CFR 1.132 received on 18 August 2005 is sufficient to overcome the rejection of claims 1-6, 8, 13, 15, 20, 26, 30-32, 34-38, 40, 43, 45, 47, 52, 58, 62 under 35 USC 103(a), which is based partially upon the prior art of Kaji et al. It is noted that the applicant calculated that the pH of the etching solution taught by Kaji et al. is actually less than the applicant's as-claimed limitation of "at least 10", and experimentally verified that this etching solution taught by Kaji et al. was reasonably close to the calculated value of 8.43. Accordingly, the rejection under 35 USC 103, which is based on using the wrong pH determination of 13.6, is hereby withdrawn.

Election/Restrictions

2. Claims 9-12, 14, 16-19, 21-25, 27-29, 33, 41-42, 44, 46, 48-51, 53-57, 59-61 are withdrawn from further consideration pursuant to 37 CFR 1.142(b), as being drawn to nonelected species, there being no allowable generic or linking claim. Claims 7, 39 are

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rejoined because applicant has amended them to read on the elected ammonium hydroxide species. Applicant timely traversed the restriction (election) requirement in the reply received on 22 November 2004.

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 1-8, 13, 15, 20, 26, 30-32, 34-40, 43, 45, 47, 52, 58, 62 are rejected under 35 U.S.C. 103(a) as being unpatentable over Fujiwara et al. (US 5,155,058) in view of Chance (US 3,434,896) and Kaji et al. (US 5,650,043).

Referring to Figs. 6-7 and column 5, line 60 to column 6, line 50, Fujiwara et al. disclose a method of removing silicon from a substrate that includes depositing a layer comprising undoped silicon in elemental form (107) over a substrate (104) that includes an oxide layer (105) and a nitride layer (106). Fujiwara et al. further disclose the selective removal of some silicon from the silicon layer (107), relative to the oxide layer (105) and the nitride layer (106), to form a flattened silicon layer (108) as shown in Figs. 6D and 7B. These are limitations as set forth in claims 1, 20, 26, 31, 32, 52, 58 of the applicant's invention.

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However, Fujiwara et al. lack the limitations of independent claims 1, 31 of exposing the silicon layer to a liquid etching solution that includes hydroxide and fluorine and has a pH of at least 10. Also, Fujiwara et al. lack the further limitations to claim 1 as set forth in claims 2-8, 13, 15, 30 and the further limitations to claim 31 as set forth in claims 34-40, 43, 45, 47, 62.

Chance teaches a liquid etching solution for etching silicon monoxide that includes ammonium fluoride and an alkaline agent for adjusting the pH to be within the range of 7.5 to 14. The most preferred alkaline agent is ammonium hydroxide. Kaji et al. teach that similar wet etching chemistries are also suitable for etching silicon (see column 5, line 9 to column 6, line 3), which would suggest that their would be a reasonable expectation for success in applying the liquid etching solution of Chance for etching elemental silicon layers.

Therefore it would have been obvious to a person of ordinary skill in the art at the time the invention was made to combine the teachings of Fujiwara et al., Chance, and Kaji et al. in order to use the liquid etching solution of Chance for etching the silicon layer of Fujiwara et al. Kaji et al. recognize that wet etching processes are advantageous over dry etching processes like the RIE process of Fujiwara et al. because they do not involve energy beam irradiation, which results in the formation of defects (see column 1, lines 12-24), and they retain atomic order flatness (see column 5, line 9 to column 6, line 3).

Regarding the limitations of claims 5-7, 37-39, these claimed ranges are *prima* facie obvious unless the applicant can show unexpected results relative to the liquid

etching solutions of Chance, since it has been held that claimed ranges of a result effective variable, which do not overlap the prior art ranges, are unpatentable unless they produce a new and unexpected result which is different in kind and not merely in degree from the results of the prior art [see *In re Woodruff*, 16 USPQ2d 1935, 1937 (Fed. Cir. 1990) and *In re Huang*, 40 USPQ2d 1685, 1688 (Fed. Cir. 1996)].

Regarding claims 30, 62, Kaji et al. recognize that the presence of fluoride is effective at retaining atomic order flatness (see column 5, line 9 to column 6, line 3).

Conclusion

- 5. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Li teaches the selective etching of polysilicon with an aqueous solution that includes ammonium fluoride and ammonium hydroxide. O. Tabata teaches the use of ammonium hydroxide for etching silicon.
- 6. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Stephen W. Smoot whose telephone number is 571-272-1698. The examiner can normally be reached on M-F (8:00 am to 4:30 pm).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Carl Whitehead, Jr. can be reached on 571-272-1702. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Business Center (EBC) at 866-217-9197 (toll-free).

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STEPHEN W. SMOOT PRIMARY EXAMINER